Authorized Representative*  Title - Representative  Phone - Representative*  Email - Representative*	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.						
Company name* Company unique ID Unique ID Authority  2024-05-01  Contact Name Title - Contact Phone - Contact* Product-Env-Stewards Authorized Representative* Product-Env-Stewards Product Enviro Compliance Title - Representative Product-Env-Stewards Product-Env	rials and Mfg Information						
Contact Name   Title - Contact   Phone - Contact   Phone - Contact   Email - Contact   Product-Env-Stewards   Product Enviro Compliance   NA   Product-Env-Stewards@onsen   Unthorized Representative*   Phone - Representative*   Phone - Representative   Phone - Representative   Product-Env-Stewards@onsen   Requester Item Number   Mfr Item Number   Mfr Item Name   Effective Date   Version   Manufacturing Site   Weight*   UOM							
Contact Name    Title - Contact   Phone - Contact   Phone - Contact   Product-Env-Stewards   Product-Env-Stewards   Product-Env-Stewards   Product-Env-Stewards   Product-Env-Stewards   Phone - Representative   Phone - Representative   Phone - Representative   Product-Env-Stewards   Product-Env-Ste	Response Date*						
Product-Env-Stewards Authorized Representative*  Product-Env-Stewards  Title - Representative  Product-Env-Stewards  Product-Env-Stewards  Product-Env-Stewards  Product-Env-Stewards  Product-Env-Stewards  Product-Env-Stewards©onsen  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  MURA110T3G  REC SMA 1A 100V ULTFST TR  2024-05-01  CNP  76.66  mg	2024-05-01						
Authorized Representative*  Product-Env-Stewards  Product Enviro Compliance  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  MURA110T3G  REC SMA 1A 100V ULTFST TR  2024-05-01  CNP  76.66  mg	Email - Contact*						
Product-Env-Stewards    Product Enviro Compliance   NA   Product-Env-Stewards@onsen	Product-Env-Stewards@onsemi.com						
Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM MURA110T3G REC SMA 1A 100V ULTFST TR 2024-05-01 CNP 76.66 mg	Email - Representative*						
MURA110T3G REC SMA 1A 100V ULTFST TR 2024-05-01 CNP 76.66 mg	Product-Env-Stewards@onsemi.com						
	Unit Type						
Janufacturing Proccess Information	Each						
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow	vales						
	ycies						
viatte III (SII) - aimeaieu CO Anoy I 200 C 30 Seconds S							
omments							
vel 1 - maximum time at peak temperature during soldering is 10-30 seconds or more information regarding material composition please refer to page 3							

<b>RoHS Material Composition Declaration</b>			Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		by mass (100 PPM) in homogeneous material for tum (Cr6+), Polybrominated Biphenyls (PBB), Polyl Disobutyl phthalate (DIBP).							
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.									
RoHS Declaration * 4 - Item(s	s) does not contain RoHS restricted substance	ces per the definition above except for selected exer	nptions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).  Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature R		,							

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	7.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.014	mg
			В	Nickel (Ni)	7440-02-0		0.0252	mg
			Supplier	Iron (Fe)	7439-89-6		0.1778	mg
			Supplier	Copper (Cu)	7440-50-8		6.7725	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0105	mg
Die	1.12	mg	Supplier	Silicon (Si)	7440-21-3		1.1088	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	0.0112	mg
Die Attach Solder	3.45	mg	Supplier	Silver (Ag)	7440-22-4		0.0862	mg
			A	Lead (Pb)	7439-92-1	7a	3.1913	mg
			Supplier	Tin (Sn)	7440-31-5		0.1725	mg
Lead Frame	28.84	mg	Supplier	Zinc (Zn)	7440-66-6		0.0346	mg
			Supplier	Iron (Fe)	7439-89-6		0.6922	mg
			Supplier	Copper (Cu)	7440-50-8		28.0902	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0231	mg
Mold Compound-Black	34.87	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.487	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1743	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		5.0561	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		22.6655	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		3.487	mg
Plating	1.38	mg	Supplier	Tin (Sn)	7440-31-5		1.38	mg